

Title (en)

CERAMIC HONEYCOMB STRUCTURE AND PROCESS FOR PRODUCING CERAMIC HONEYCOMB STRUCTURE

Title (de)

KERAMIKWABENSTRUKTUR UND VERFAHREN ZUR HERSTELLUNG EINER KERAMIKWABENSTRUKTUR

Title (fr)

STRUCTURE CÉRAMIQUE EN NID D'ABEILLE ET SON PROCÉDÉ DE FABRICATION

Publication

EP 2070576 B1 20140319 (EN)

Application

EP 07828620 A 20070927

Priority

- JP 2007068874 W 20070927
- JP 2006265107 A 20060928

Abstract (en)

[origin: EP2070576A1] A ceramic honeycomb structure having porous cell walls defining large numbers of flow paths, the cell walls having porosity of 55-70%, an average pore diameter of 10-40 μm , a concave area ratio CR (projected area ratio of portions lower than an average surface determined from cell wall surface roughness by a least square method) of 0.32-0.6, and an average concave depth H concave (average depth of portions lower than the average surface) of 0.02-0.1 mm.

IPC 8 full level

C04B 35/195 (2006.01); **B01D 46/24** (2006.01); **F01N 3/022** (2006.01)

CPC (source: EP US)

B01D 46/2425 (2013.01 - EP US); **B01D 46/2429** (2013.01 - EP US); **B01D 46/24491** (2021.08 - EP US); **B01D 46/24492** (2021.08 - EP US); **B01D 46/24494** (2021.08 - EP US); **B01D 46/2455** (2013.01 - US); **B01D 46/2482** (2021.08 - EP US); **B01D 46/2484** (2021.08 - EP US); **B01D 46/2498** (2021.08 - EP); **C04B 35/195** (2013.01 - EP US); **C04B 38/0006** (2013.01 - EP US); **F01N 3/0222** (2013.01 - EP US); **B01D 46/2498** (2021.08 - US); **C04B 2235/3217** (2013.01 - EP US); **C04B 2235/3218** (2013.01 - EP US); **C04B 2235/3418** (2013.01 - EP US); **C04B 2235/349** (2013.01 - EP US); **C04B 2235/5296** (2013.01 - EP US); **C04B 2235/5409** (2013.01 - EP US); **C04B 2235/5436** (2013.01 - EP US); **C04B 2235/9607** (2013.01 - EP US); **F01N 2330/06** (2013.01 - EP US); **F01N 2330/38** (2013.01 - EP US); **Y02T 10/12** (2013.01 - EP US); **Y10T 428/24149** (2015.01 - EP US)

Designated contracting state (EPC)

DE FR

DOCDB simple family (publication)

EP 2070576 A1 20090617; **EP 2070576 A4 20120509**; **EP 2070576 B1 20140319**; CN 101460230 A 20090617; CN 101460230 B 20120201; JP 5315997 B2 20131016; JP WO2008047558 A1 20100225; US 2009142543 A1 20090604; US 7833606 B2 20101116; WO 2008047558 A1 20080424

DOCDB simple family (application)

EP 07828620 A 20070927; CN 200780020784 A 20070927; JP 2007068874 W 20070927; JP 2008539719 A 20070927; US 30346607 A 20070927